

# **Not for New Design**

Vishay Semiconductors

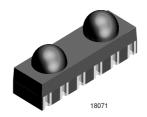
# Serial Infrared Transceiver SIR, 115.2 kbit/s, 2.7 V to 5.5 V Operation

#### **Description**

The TFBS4710 is a low profile, full range Infrared Data Transceiver module. It supports IrDA data rates up to 115.2 kbit/s (SIR). The transceiver module consists of a photo PIN photodiode, an infrared emitter (IRED), and a low-power CMOS control IC to provide a total front-end solution in a single package.

The device has a link distance of 1 meter. The Rxd pulse width is independent of the duration of Txd pulse and always stays at a fixed width thus making





the device optimum for all standard SIR Encoder/ Decoder and interfaces. The Shut Down (SD) feature cuts current consumption to typically 10 nA.

#### **Features**

- Compliant with the latest IrDA physical layer specification ( 9.6 kbit/s to 115.2 kbit/s)
- Small package: H 2.74 mm x D 3.33 mm x L 8.96 mm
- · Typical Link distance 1 m
- Drop in replacement for IRM5000D/ IRMT5000
- · Battery & Power Management Features:
  - > Idle Current 75 μA Typical
  - > Shutdown Current 10 nA Typical
  - > Operates from 2.4 V 5.0 V within specification over full temperature range from 25  $^{\circ}$ C to + 85  $^{\circ}$ C
- Remote Control transmit distance up to 8 meters
- Tri-State Receiver Output, floating in shutdown with a weak pull-up
- Fixed Rxd output pulse width (2 μs typical)
- Meets IrFM Fast Connection requirements

- Split power supply, an independant, unregulated supply for IRED Anode and a well regulated supply for V<sub>CC</sub>
- Directly Interfaces with Various Super I/O and Controller Devices and Encoder/ Decoder such as TOIM4232.

#### **Applications**

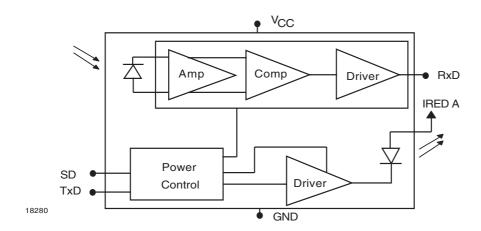
- · Ideal for Battery Operated Devices
- PDAs
- Mobile Phones
- Electronic Wallet (IrFM)
- Notebook Computers
- · Digital Still and Video Cameras
- Printers, Fax Machines, Photocopiers, Screen Projectors
- Data Loggers
- External Infrared Adapters (Dongles)
- · Diagnostics Systems
- Medical and Industrial Data Collection Devices

#### **Parts Table**

| Part         | Description   | Qty / Reel |  |
|--------------|---|------------|--|
| TFBS4710-TR1 | Oriented in carrier tape for side view surface mounting | 1000 pcs   |  |
| TFBS4710-TT1 | Oriented in carrier tape for top view surface mounting  | 1000 pcs   |  |

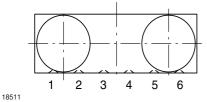


#### **Functional Block Diagram**



#### **Pinout**

TFBS4710 weight 100 mg



#### **Definitions:**

In the Vishay transceiver data sheets the following nomenclature is used for defining the IrDA operating modes:

SIR: 2.4 kbit/s to 115.2 kbit/s, equivalent to the basic serial infrared standard with the physical layer version IrPhy 1.0

MIR: 576 kbit/s to 1152 kbit/s

FIR: 4 Mbit/s VFIR: 16 Mbit/s

MIR and FIR were implemented with IrPhy 1.1, followed by IrPhy 1.2, adding the SIR Low Power Standard. IrPhy 1.3 extended the Low Power Option to MIR and FIR and VFIR was added with IrPhy 1.4.A new version of the standard in any case obsoletes the former version.

With introducing the updated versions the old versions are obsolete. Therefore the only valid IrDA standard is the actual version IrPhy 1.4 (in Oct. 2002).

#### **Pin Description**

| Pin Number | Function        | Description  | I/O | Active |
|------------|-----------------|--|-----|--------|
| 1          | IRED<br>Anode   | IRED Anode is connected to a power supply. The LED current can be decreased by adding a resistor in series between the power supply and IRED Anode. A separate unregulated power supply can be used at this pin. |     |        |
| 2          | Txd             | This Input is used to turn on IRED transmitter when SD is low. An on-chip protection circuit disables the LED driver if the Txd pin is asserted for longer than $80~\mu s$                                       | I   | HIGH   |
| 3          | Rxd             | Received Data Output, normally stays high but goes low for a fixed duration during received pulses. It is capable of driving a standard CMOS or TTL load.  | 0   | LOW    |
| 4          | SD              | Shutdown. Setting this pin active for more than 1.5 ms switches the device into shutdown mode  | I   | HIGH   |
| 5          | V <sub>CC</sub> | Regulated Supply Voltage   |     |        |
| 6          | GND             | Ground   |     |        |

www.vishay.com

Document Number 82612

Rev. 1.3, 11-Nov-03



#### **Absolute Maximum Ratings**

Reference Point Ground, Pin 6 unless otherwise noted.

| Parameter                             | Test Conditions                              | Symbol                 | Min   | Тур. | Max   | Unit |
|---------------------------------------|--|------------------------|-------|------|-------|------|
| Supply voltage range, all states      |  | V <sub>CC</sub>        | - 0.3 |      | + 6.0 | V    |
| Input current                         | For all Pins except IRED Anode Pin           | I <sub>CC</sub>        |       |      | 10.0  | mA   |
| Output Sink Current, Rxd              |  |                        |       |      | 25.0  | mA   |
| Average output current, pin 1         | 20 % duty cycle                              | I <sub>IRED</sub> (DC) |       |      | 60    | mA   |
| Repetitive pulsed output current      | < 90 μs, t <sub>on</sub> < 20 %              | I <sub>IRED</sub> (RP) |       |      | 300   | mA   |
| IRED anode voltage, pin 1             |  | V <sub>IREDA</sub>     | - 0.5 |      | + 6.0 | V    |
| Voltage at all inputs and outputs     | V <sub>in</sub> > V <sub>CC</sub> is allowed | V <sub>IN</sub>        | - 0.5 |      | + 6.0 | V    |
| Power dissipation                     | See derating curve                           |                        |       |      | 200   | mW   |
| Junction temperature                  |  |                        |       |      | 125   | °C   |
| Ambient temperature range (operating) |  | T <sub>amb</sub>       | - 30  |      | + 85  | °C   |
| Storage temperature range             |  | T <sub>stg</sub>       | - 40  |      | + 100 | °C   |
| Soldering temperature                 | See Recommended Solder<br>Profile            |                        |       |      | 240   | °C   |

#### **Electrical Characteristics**

#### **Transceiver**

 $T_{amb}$  = 25 °C,  $V_{CC}$  =  $V_{IREDA}$  = 2.4 V to 5.5 V unless otherwise noted.

| Parameter  | Test Conditions   | Symbol           | Min                   | Тур. | Max                    | Unit |
|--|---|------------------|-----------------------|------|------------------------|------|
| Supply voltage range, all states                                 |   | $V_{CC}$         | 2.4                   |      | 5.5                    | V    |
| Idle supply current @ V <sub>CC1</sub> (receive mode, no signal) | SD = Low, $E_e = 1 \text{ k/x}^{\dagger}$ ,<br>$T_{amb} = -25 \text{ °C to} + 85 \text{ °C}$ ,<br>$V_{CC1} = V_{CC2} = 2.7 \text{ V to } 5.5 \text{ V}$ | I <sub>CC1</sub> |                       | 90   | 130                    | μА   |
|  | SD = Low, $E_e = 1 \text{ k/x}^*$ ,<br>$T_{amb} = 25 \text{ °C}$ ,<br>$V_{CC1} = V_{CC2} = 2.7 \text{ V to } 5.5 \text{ V}$                             | I <sub>CC1</sub> |                       | 75   |                        | μА   |
| Receive current  | V <sub>CC</sub> = 2.7 V   | I <sub>CC</sub>  |                       | 280  |                        | μΑ   |
| Shutdown current   | $SD = High, T = 25  ^{\circ}C, E_e = 0  klx$  | I <sub>SD</sub>  |                       |      | 2                      | μΑ   |
|  | SD = High, T = 85 °C  | I <sub>SD</sub>  |                       |      | 3                      | μΑ   |
| Operating temperature range                                      |   | T <sub>A</sub>   | - 25                  |      | + 85                   | °C   |
| Output voltage low, Rxd  | I <sub>OL</sub> = 1 mA  | V <sub>OL</sub>  | - 0.5                 |      | 0.15 x V <sub>CC</sub> | V    |
| Output voltage high, Rxd   | I <sub>OH</sub> = - 500 μA  | V <sub>OH</sub>  | 0.8 x V <sub>CC</sub> |      | V <sub>CC</sub> + 0.5  | V    |
|  | I <sub>OH</sub> = - 250 μA  | V <sub>OH</sub>  | 0.9 x V <sub>CC</sub> |      | V <sub>CC</sub> + 0.5  | V    |
| Rxd to V <sub>CC</sub> impedance                                 |   | R <sub>Rxd</sub> | 400                   | 500  | 600                    | kΩ   |
| Input voltage low: Txd, SD                                       |   | V <sub>IL</sub>  | - 0.5                 |      | 0.5                    | V    |
| Input voltage high: Txd, SD                                      | CMOS level (0.5 x V <sub>CC</sub> typ, threshold level)   | $V_{IH}$         | V <sub>CC</sub> - 0.5 |      | 6.0                    | V    |
| Input leakage current (Txd, SD)                                  | $V_{in} = 0.9 \times V_{CC}$  | I <sub>ICH</sub> | - 2                   |      | + 2                    | μΑ   |

# **TFBS4710**

#### **Vishay Semiconductors**



| Parameter                    | Test Conditions   | Symbol            | Min | Тур. | Max   | Unit |
|------------------------------|---|-------------------|-----|------|-------|------|
| Controlled pull down current | SD, Txd = "0" or "1",<br>0 < V <sub>in</sub> < 0.15 V <sub>CC</sub> | I <sub>IRTx</sub> |     |      | + 150 | μА   |
|                              | SD, Txd = "0" or "1"<br>V <sub>in</sub> > 0.7 V <sub>CC</sub>       | I <sub>IRTx</sub> | - 1 | 0    | 1     | μА   |
| Input capacitance            |   | C <sub>I</sub>    |     |      | 5     | pF   |

### **Optoelectronic Characteristics**

#### Receiver

 $\rm T_{amb}$  = 25 °C,  $\rm V_{CC}$  = 2.4 V to 5.5 V unless otherwise noted

| Parameter  | Test Conditions  | Symbol              | Min         | Тур.        | Max        | Unit                                       |
|--|--|---------------------|-------------|-------------|------------|--|
| Minimum detection threshold irradiance, SIR mode | 9.6 kbit/s to 115.2 kbit/s $\lambda$ = 850 nm - 900 nm, $\alpha$ 0 = °, 15 ° | E <sub>e</sub>      | 10<br>(1.0) | 25<br>(2.5) | 40<br>(4)  | mW/m <sup>2</sup><br>(μW/cm <sup>2</sup> ) |
| Maximum detection threshold irradiance           | λ = 850 nm - 900 nm  | E <sub>e</sub>      |             | 5<br>(500)  |            | kW/m <sup>2</sup><br>(mW/cm <sup>2</sup> ) |
| Maximum no detection threshold irradiance        |  | E <sub>e</sub>      |             |             | 4<br>(0.4) | mW/m <sup>2</sup><br>(μW/cm <sup>2</sup> ) |
| Rise time of output signal                       | 10 % to 90 %, C <sub>L</sub> = 15 pF   | $t_{r(Rxd)}$        | 10          |             | 100        | ns   |
| Fall time of output signal                       | 90 % to 10 %, C <sub>L</sub> = 15 pF   | t <sub>f(Rxd)</sub> | 10          |             | 100        | ns   |
| Rxd pulse width                                  | Input pulse width > 1.2 μs   | t <sub>PW</sub>     | 1.65        | 2.0         | 3.0        | μS   |
| Leading edge jitter                              | Input Irradiance = 100 mW/m <sup>2</sup> ,<br>≤ 115.2 kbit/s                 |                     |             |             | 250        | ns   |
| Standby /Shutdown delay                          | After shutdown active  |                     |             |             | 150        | μS   |
| Receiver startup time                            | Power-on delay   |                     |             |             |            |  |
| Latency  |  | $t_L$               |             |             | 150        | μS   |

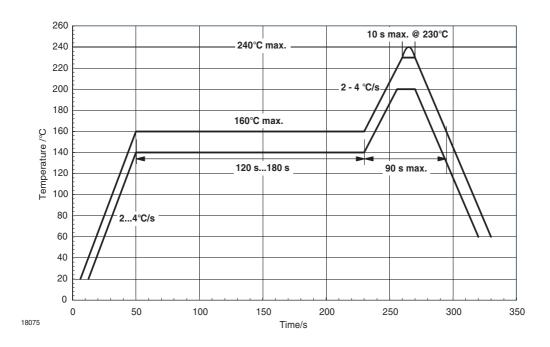
#### **Transmitter**

 $\rm T_{amb}$  = 25 °C,  $\rm V_{CC}$  = 2.4 V to 5.5 V unless otherwise noted.

| Parameter   | Test Conditions   | Symbol            | Min              | Тур. | Max      | Unit  |
|---|---|-------------------|------------------|------|----------|-------|
| IRED operating current                            |   | I <sub>D</sub>    | 250              | 300  | 350      | mA    |
| IRED forward voltage                              | I <sub>r</sub> = 300 mA   | V <sub>f</sub>    | 1.4              | 1.8  | 1.9      | V     |
| IRED leakage current                              | $Txd = 0 V, 0 < V_{CC} < 5.5 V$   | I <sub>IRED</sub> | - 1              |      | 1        | μΑ    |
| Output radiant intensity                          | $\alpha$ = 0 °, 15 °, Txd = High, SD = Low  | l <sub>e</sub>    | 40               | 70   | 350      | mW/sr |
|   | $V_{CC}$ = 5.0 V, $\alpha$ = 0 °, 15 °, Txd = High or SD = High (Receiver is inactive as long as SD = High) | l <sub>e</sub>    |                  |      | 0.04     | mW/sr |
| Output radiant intensity, angle of half intensity |   | α                 |                  | ± 24 |          | 0     |
| Peak-emission wavelength                          |   | λ <sub>P</sub>    | 880              |      | 900      | nm    |
| Spectral bandwidth                                |   | Δλ                |                  | 45   |          | nm    |
| Optical rise time                                 |   | t <sub>ropt</sub> | 10               |      | 100      | ns    |
| Optical fall time                                 |   | t <sub>fopt</sub> | 10               |      | 100      | ns    |
| Optical output pulse duration                     | Input pulse width 1.63 μs, 115.2 kbit/s   | t <sub>opt</sub>  | 1.46             | 1.63 | 1.8      | μS    |
|   | Input pulse width t <sub>Txd</sub> < 20 μs  | t <sub>opt</sub>  | t <sub>Txd</sub> |      | t + 0.15 | μS    |
|   | Input pulse width $t_{Txd} \ge 20 \ \mu s$  | t <sub>opt</sub>  |                  |      | 50       | μS    |
| Optical overshoot                                 |   |                   |                  |      | 25       | %     |



#### **Recommended Solder Profile**



#### **Recommended Circuit Diagram**

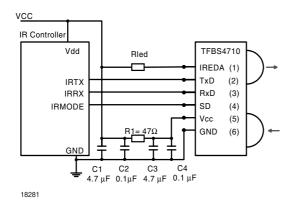


Figure 1. Recommended Application Circuit

The TFBS4710 integrates a sensitive receiver and a built-in power driver. This combination needs a careful circuit layout. The use of thin, long, resistive and inductive wiring should be avoided. The inputs (Txd, SD) and the output (Rxd) should be directly (DC) coupled to the I/O circuit.

The combination of resistor R1 and capacitors C1, C2, C3 and C4 filter out any power supply noise to provide a smooth supply voltage.

The placement of these components is critical. It is strongly recommended to position C3 and C4 as close as possible to the transceiver power supply pins. A Tantalum capacitor should be used for C1 and C3 while a ceramic capacitor should be used for C2 and C4.

A current limiting resistor is not needed for normal operation. It is strongly recommended to use the Rled values mentioned in Table 1 below for high temperature operation. For Low Power Mode, IRED Anode voltage of less than 5 V is recommended.

Under extreme EMI conditions as placing a RF - transmitter antenna on top of the transceiver, it is recommended to protect all inputs by a low-pass filter, as a minimum a 12 pF capacitor, especially at the Rxd port.

Basic RF design rules for circuit design should be followed. Especially longer signal lines should not be used without proper termination. For reference see "The Art of Electronics" by Paul Horowitz, Winfield Hill, 1989, Cambridge University Press, ISBN: 0521370957.



Table 1. High Operating Temperature > 70 °C

|                      | Rled (Ω)   | Rled $(\Omega)$ )                                      |
|----------------------|--|--|
| V <sub>LED</sub> (V) | Standard Power Mode<br>(Intensity > 40 mW/sr,<br>0 - 15 °) | Low Power Mode<br>(Intensity > 3.6 mW/sr,<br>0 - 15 °) |
| 2.7                  | 3  | 50   |
| 3.3                  | 16   | > 50   |
| 5.0                  | 18   | > 60   |

#### I/O and Software

In the description, already different I/Os are mentioned. Different combinations are tested and the function verified with the special drivers available from the I/O suppliers. In special cases refer to the I/O manual, the Vishay application notes, or contact directly Vishay Sales, Marketing or Application.

Table 2. Recommended Application Circuit Components

| Compo<br>nent | Recommended Value     | Vishay Part Number   |
|---------------|-----------------------|----------------------|
| C1, C3        | 4.7 μ <b>F</b> , 16 V | 293D 475X9 016B      |
| C2, C4        | 0.1 μF, Ceramic       | VJ 1206 Y 104 J XXMT |
| R1            | 47 Ω, 0.125 W         | CRCW-1206-47R0-F-RT1 |
| Rled          | See Table 1           |                      |

Table 3. Truth table

|                |              | Inputs   | Outputs   |                | Remark   |  |
|----------------|--------------|--|---|----------------|--|--|
| SD             | Txd          | Optical input Irradiance<br>mW/m <sup>2</sup>                                  | Rxd   | Transmitt er   | Operation  |  |
| high<br>> 1 ms | х            | х  | weakly pulled (500 $\Omega$ ) to V <sub>CC1</sub> | 0              | Shutdown   |  |
| low            | high         | х  | high inactive                                     | l <sub>e</sub> | Transmitting   |  |
| low            | high<br>> μs | X  | high inactive                                     | 0              | Protection is active   |  |
| low            | low          | < 4  | high inactive                                     | 0              | Ignoring low signals below the IrDA defined threshold for noise immunity |  |
| low            | low          | > Min. Detection Threshold Irradiance<br>< Max. Detection Threshold Irradiance | low (active)                                      | 0              | Response to an IrDA compliant optical input signal                       |  |
| low            | low          | > Max. Detection Threshold Irradiance  | undefined   | 0              | Overload conditions can cause unexpected outputs                         |  |

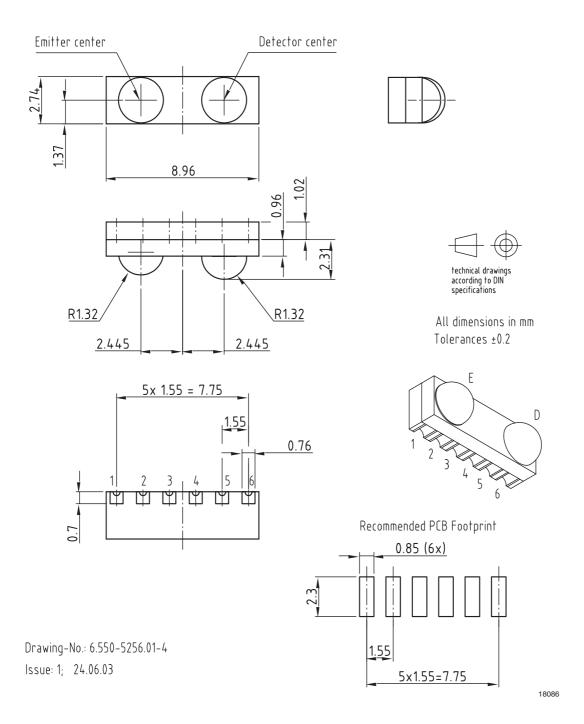
www.vishay.com

Document Number 82612

Rev. 1.3, 11-Nov-03

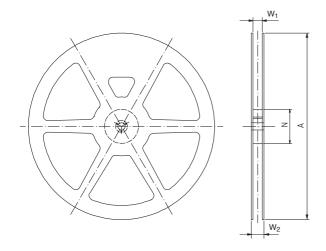


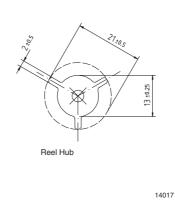
#### Package Dimensions in mm



# VISHAY

#### **Reel Dimensions**





| Tape Width | A max. | N  | W <sub>1</sub> min. | W <sub>2</sub> max. | W <sub>3</sub> min. | W <sub>3</sub> max. |
|------------|--------|----|---------------------|---------------------|---------------------|---------------------|
| mm         | mm     | mm | mm                  | mm                  | mm                  | mm                  |
| 16         | 330    | 50 | 16.4                | 22.4                | 15.9                | 19.4                |

www.vishay.com

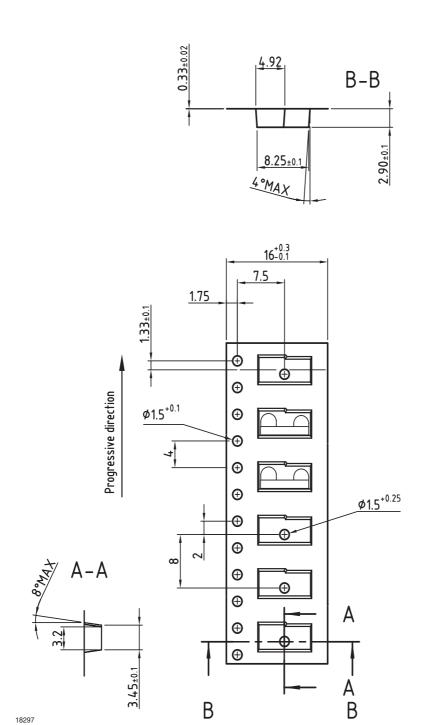
Bocument Number 82612

Rev. 1.3, 11-Nov-03





#### **Tape Dimensions in mm**



#### **TFBS4710**

#### **Vishay Semiconductors**



#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operatingsystems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

#### We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

> Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423

Document Number 82612 www.vishay.com Rev. 1.3, 11-Nov-03